Product Change Notification

H-811.I2V: Improved Heat Dissipation and EMC

Change Description

The following changes were made to the H-811.I2V:

- EMC-improved connecting cable
  The raw cable of the connecting cable is replaced by two twisted pair raw cables.
  Result: Improvement of electromagnetic compatibility (EMC)
- Improved driver board heat dissipation
  For better heat dissipation, a braided hose is soldered to the driver board and screwed to the base plate with a ring cable lug.
  Result: Improvement of heat dissipation for the driver board in the actuator

Impact and Reasons

- Improvement of electromagnetic compatibility (EMC) due to the EMC-improved connecting cable.
- Improvement of heat dissipation for the driver board in the actuator due to the added braided hose.

Affected Products and Schedule

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<td>EMC-improved connecting cable and improved driver board heat dissipation</td>
<td>June 1, 2020</td>
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